CNIEE 172

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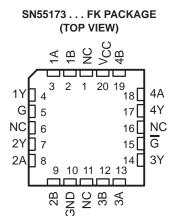
IDACKACE

- Meet or Exceed the Requirements of TIA/EIA-422-B, TIA/EIA-423-B, and TIA/EIA-485-A and ITU Recommendations V.10, V.11, X.26, and X.27
- Designed for Multipoint Bus Transmission on Long Bus Lines in Noisy Environments
- 3-State Outputs
- Common-Mode Input Voltage Range of -12 V to 12 V
- Input Sensitivity ... ±200 mV
- Input Hysteresis . . . 50 mV Typ
- High Input Impedance . . . 12 kΩ Min
- Operate From Single 5-V Supply
- Low Power Requirements
- Pin-to-Pin Replacement for AM26LS32

### description

The SN55173, SN65173, and SN75173 are monolithic quadruple differential line receivers with 3-state outputs. They are designed to meet requirements of TIA/EIA-422-B, the TIA/EIA-423-B, TIA/EIA-485-A, and several ITU recommendations. The standards are for balanced multipoint bus transmission at rates up to 10 megabits per second. The four receivers share two OR enable inputs, one active when high, the other active when low. These devices feature high input impedance, input hysteresis for increased noise immunity, and input sensitivity of ±200 mV over a common-mode input voltage range of –12 V to 12 V. Fail-safe design specifies that if the inputs are open circuited, the outputs are always high. The SN65173 and SN75173 are designed for optimum performance when used with the SN75172 or SN75174 quad differential line drivers.

SN55173J PACKAGE							
SN65173, SN75	173	D OF	R N PACKAGE				
(TOP VIEW)							
	101 11	<b></b> ,					
L	$- \mathbf{\nabla}$						
1B 🛛	1	16	V <sub>CC</sub>				
1A [	2	15	4B				
1Y [	3	14	4A				
G [	4	13	4Y				
2Y [	5	12	G				
2A [	6	11	3Y				
2B 🛛	7	10	3A				
GND 🛛	8	9	3B				
l							



NC-No internal connection

### THE SN55173 IS NOT RECOMMENDED FOR NEW DESIGNS.

The SN55173 is characterized over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN65173 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C. The SN75173 is characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.



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AVAILABLE OPTIONS							
	PACKAGED DEVICES						
TA	PLASTIC SMALL OUTLINE (D)	CERAMIC DIP (J)	PLASTIC DIP (N)				
0°C to 70°C	SN75173D	—	—	SN75173N			
-40°C to 85°C	SN65173D	—	—	SN65173N			
–55°C to 125°C	—	SN55173FK	SN55173J	—			

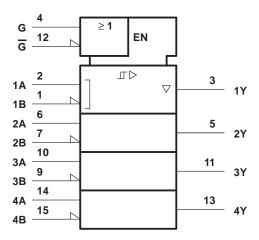
The D package is available taped and reeled. Add the suffix R to the device type (e.g., SN75173DR).

**FUNCTION TABLE** 

(each receiver)							
DIFFERENTIAL	ENA	BLES	OUTPUT				
A–B	G	G	Y				
	Н	Х	Н				
$V_{ID} \ge 0.2 V$	Х	L	Н				
	Н	Х	?				
$-0.2 V < V_{ID} < 0.2 V$	Х	L	?				
	Н	Х	L				
$V_{ID} \leq -0.2 V$	Х	L	L				
Х	L	Н	Z				
Open circuit	Х	L	Н				
	Н	Х	Н				

H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)

# logic symbol †

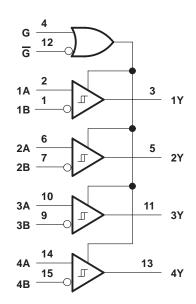


 $\dagger$  This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.



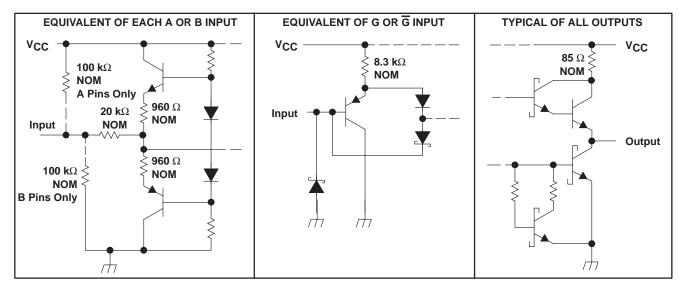
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## logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

## schematics of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise	noted)†
Supply voltage, V <sub>CC</sub> (see Note 1)	-
Input voltage (V <sub>1</sub> or B inputs)	
Differential input voltage, V <sub>ID</sub> (see Note 2)	
Enable input voltage, V <sub>I</sub>	7 V
Low-level output current, I <sub>OL</sub>	50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): D package	. 73°C/W
N package	. 67°C/W
Continuous total dissipation Radiation Ra	ting Table
Case temperature for 60 seconds, T <sub>C</sub> : FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or N package	
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J package	
Storage temperature range, T <sub>stg</sub> 65°C	to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.

- 2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.
- 3. The package thermal impedance is calculated in accordance with JESD 51.

### DISSIPATION RATING TABLE

PACKAGE	T <sub>A</sub> ≤ 25°C POWER RATING	DERATING FACTOR	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 125°C POWER RATING
FK	1375 mW	11 mW/°C	880 mW	275 mW
J	1375 mW	11 mW/°C	880 mW	275 mW

## recommended operating conditions

		MIN	NOM	MAX	UNIT
	SN55173		5	5.5	V
Supply voltage, V <sub>CC</sub>	SN65173, SN75173	4.75	5	5.25	V
Common-mode input voltage, VIC				±12	V
Differential input voltage, VID				±12	V
High-level enable-input voltage, VIH		2			V
Low-level enable-input voltage, VIL				0.8	V
High-level output current, I <sub>OH</sub>				-400	μΑ
Low-level output current, IOL				16	mA
	SN55173	-55		125	
Operating free-air temperature, TA	SN65173			85	°C
	SN75173	0		70	



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### electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature

	PARAMETER	TES	TEST CONDITIONS			TYP <sup>†</sup>	MAX	UNIT
$V_{IT+}$	Positive-going input threshold voltage	V <sub>O</sub> = 2.7 V,	$I_{O} = -0.4 \text{ mA}$				0.2	V
$V_{IT-}$	Negative-going input threshold voltage	$V_{O} = 0.5 V,$	l <sub>O</sub> = 16 mA		-0.2‡			V
V <sub>hys</sub>	Hysteresis (V <sub>IT+</sub> – V <sub>IT</sub> _)	See Figure 4				50		mV
VIK	Enable-input clamp voltage	lj = – 18 mA					-1.5	V
				SN55173	2.5			V
∨он	High-level output voltage	V <sub>ID</sub> = 200 mV,	I <sub>OH</sub> = -400 μA	SN65173, SN75173	2.7			V
\/		)/ 000 m)/		I <sub>OL</sub> = 8 mA			0.45	V
VOL	Low-level output voltage	$V_{ID} = -200 \text{ mV}$ , See Figure 1		I <sub>OL</sub> = 16 mA			0.5	v
I <sub>OZ</sub>	High-impedance-state output current	$V_{O} = 0.4 \text{ V to } 2.4 \text{ V}$					±20	μΑ
1.		Other input at 0.1/	Other input at 0 V. See Note 3		1	mA		
1	Line input current	Other input at 0 V,	See Note S	$V_{I} = -7 V$			-0.8	IIIA
IIH	High-level enable-input current	V <sub>IH</sub> = 2.7 V					20	μΑ
IIL	Low-level enable-input current	V <sub>IL</sub> = 0.4 V					-100	μΑ
ri	Input resistance				12			kΩ
los	Short-circuit output current				-15		-85	mA
ICC	Supply current	Outputs disabled					70	mA

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. <sup>‡</sup> The algebraic convention, in which the less positive (more negative) limit is designated as minimum, is used in this data sheet for threshold voltage levels only.

NOTE 3: Refer to TIA/EIA-422-B and TIA/EIA-423-B for exact conditions.

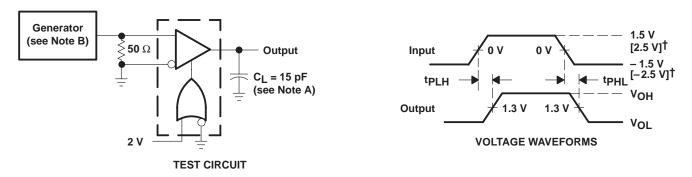
## switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output	V <sub>ID</sub> = -1.5 V	to 1.5 V,		20	35	ns
<sup>t</sup> PHL	Propagation delay time, high-to-low-level output	C <sub>L</sub> = 15 pF,	See Figure 1		22	35	ns
<sup>t</sup> PZH	Output enable time to high level	C <sub>L</sub> = 15 pF,	See Figure 2		17	22	ns
tPZL	Output enable time to low level	C <sub>L</sub> = 15 pF,	See Figure 3		20	25	ns
<sup>t</sup> PHZ	Output disable time from high level	C <sub>L</sub> = 5 pF,	See Figure 2		21	30	ns
t <sub>PLZ</sub>	Output disable time from low level	C <sub>L</sub> = 5 pF,	See Figure 3		30	40	ns



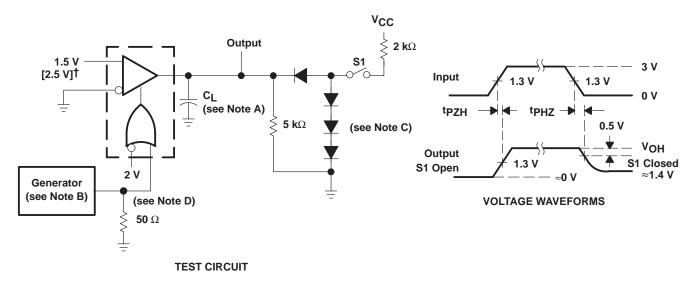
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## PARAMETER MEASUREMENT INFORMATION



<sup>†</sup> Voltage for the SN55173 only.

- NOTES: A. CL includes probe and jig capacitance.
  - B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%,  $t_f \le 6$  ns,  $t_f \le 6$  ns,  $Z_O = 50 \Omega$ .



### Figure 1. tPLH, tPHL Test Circuit and Voltage Waveforms

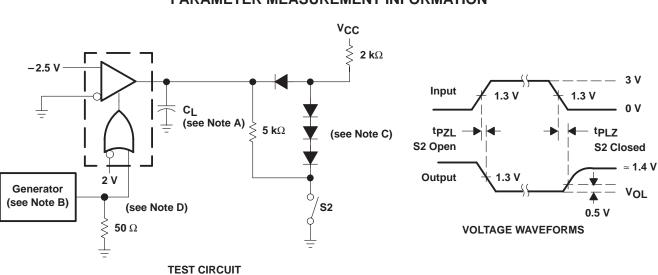
<sup>†</sup> Voltage for the SN55173 only.

- NOTES: A. CL includes probe and jig capacitance.
  - B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%,  $t_{f} \le 6$  ns,  $t_{f} \le 6$  ns,  $t_{f} \le 6$  ns,  $t_{f} \le 6$  ns,  $t_{f} \le 6$  ns, the following characteristics: PRR = 1 MHz, duty cycle = 50%,  $t_{f} \le 6$  ns, the following characteristics: PRR = 1 MHz, duty cycle = 50%, the following characteristics: PRR = 1 MHz, duty cycle = 50%, the following characteristics: PRR = 1 MHz, duty cycle = 50%, the following characteristics: PRR = 1 MHz, duty cycle = 50\%, the following characteristics: PRR =
  - C. All diodes are 1N916, or equivalent.
  - D. To test the active-low enable  $\overline{G}$ , ground G and apply an inverted input waveform to  $\overline{G}$ .

## Figure 2. t<sub>PHZ</sub>, t<sub>PZH</sub> Test Circuit and Voltage Waveforms



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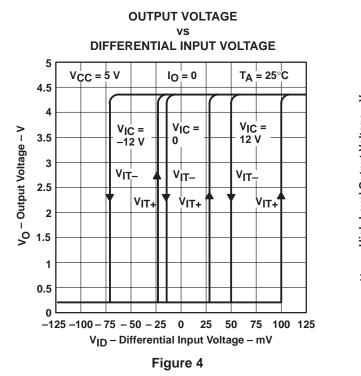
PARAMETER MEASUREMENT INFORMATION

- NOTES: A. CL includes probe and jig capacitance.
  - B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%,  $t_f \le 6$  ns,  $t_f \le 6$  ns,  $Z_O = 50 \Omega$ .
  - C. All diodes are 1N916, or equivalent.
  - D. To test the active-low enable  $\overline{G}$ , ground G and apply an inverted input waveform to  $\overline{G}$ .

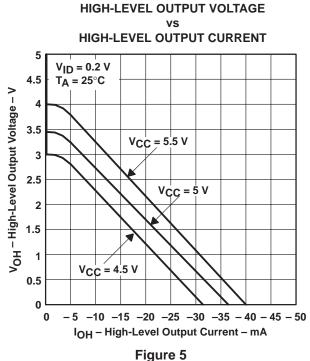
Figure 3. t<sub>PZL</sub>, t<sub>PLZ</sub> Test Circuit and Voltage Waveforms



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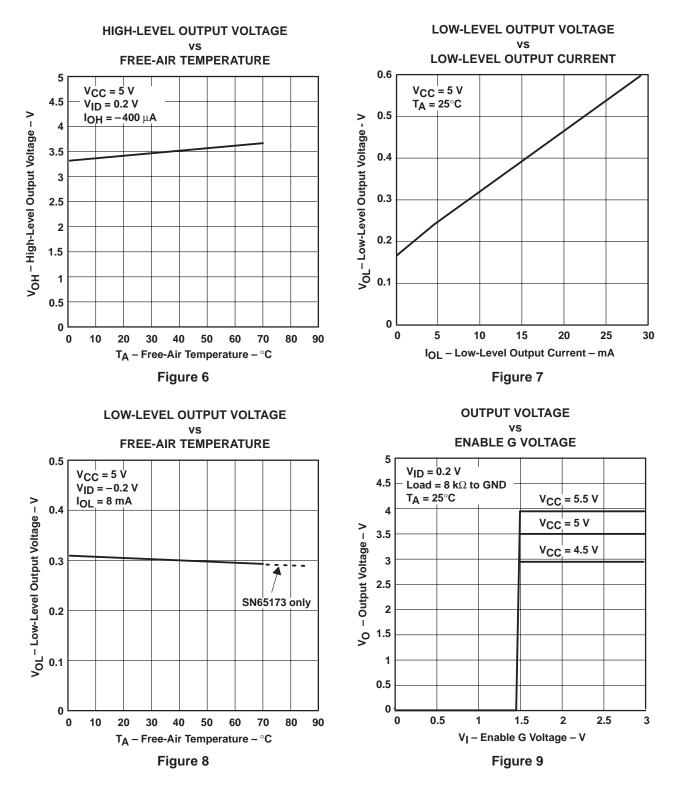




<sup>†</sup>Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



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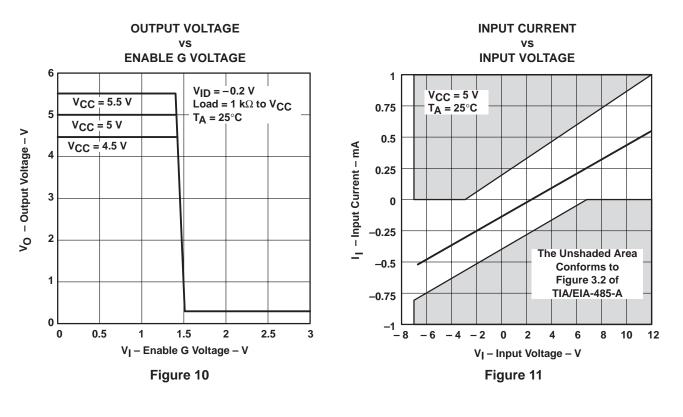


## **TYPICAL CHARACTERISTICS<sup>†</sup>**

<sup>†</sup> Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

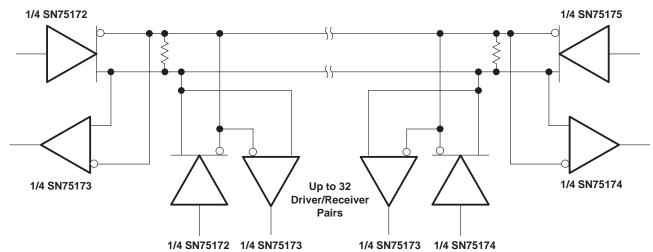


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## **TYPICAL CHARACTERISTICS**





NOTE A: The line should be terminated at both ends in its characteristic impedance. Stub lengths off the main line should be kept as short as possible.

Figure 12. Typical Application Circuit



## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	n MSL Peak Temp <sup>(3)</sup>
SN55173J	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
SN65173D	OBSOLETE	SOIC	D	16		None	Call TI	Call TI
SN65173DR	OBSOLETE	SOIC	D	16		None	Call TI	Call TI
SN65173N	OBSOLETE	PDIP	Ν	16		None	Call TI	Call TI
SN75173D	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN75173DR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN75173J	OBSOLETE	CDIP	J	16		None	Call TI	Call TI
SN75173N	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN75173NSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ55173FK	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
SNJ55173J	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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